

### Super Companion Chip with Audio Visual Interface for Cell Processor

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### Background

- What is Super Companion Chip(SCC)?
- Processing Flow
- SCC Architecture
- Technology and Chip Implementation
- Conclusion

### **Motivation**

- To provide software based digital consumer solution for Cell processor such as Digital TV, Audio Visual Server, etc.
- To establish GHz high bandwidth connection between Cell and ultra high speed peripherals on Super Companion Chip (SCC).

# **Requirements from Market**

- Multi Tasks Processing Simultaneously -



# **Cell Processor Overview**

- Power Processor Element (PPE)
- Synergistic Processor Element (SPE)
- Dual XDR DRAM channels
- Flexible I/O Interface
- Element Interconnect Bus



## **Features of Cell Processor**

### Resource Management Capability

Reserve Memory & I/O Bandwidth for up to four tasks.

#### Isolation Facility

Each SPE is isolatable from outside for flexible secure programming.

#### Multi OS Support

- Run multiple OSs simultaneously.
  - ✓ e.g. Linux + Real-time OS

# **Features of SCC**

### For Real Time Processing

SCC internal bus has the bandwidth reservation capability for the each resources.

-TDM arbitration

### For Tight Security

The HW random number generator and several kinds of HW Encryption/Decryption functions are implemented.

### For Multi OS Support

Every bus master module have the address space restriction mechanism.

To prevent the IO resource conflict between OSs.



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# **SCC I/O Category**

### For versatile A/V system

-DDR2 DRAM I/F for Video RAM.

- -Video output / Audio output.
- -Video input / Audio input.
- -Digital AV equipment connection I/F (IEEE1394).
- -Digital tuner I/F (TS I/F).

### For computer system

-Standard PC I/F (PCI-Express,PCI,USB2.0). -High-speed Network I/F (Giga Bit Ethernet). -Storage device I/F (Parallel ATA).

### **A/V functions in SCC**



## **Computer peripheral functions in SCC**





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### Audio/Visual data flow

Taking digital broadcasting and Outputting A/V data with time shift function.



# **Data Processing Flow**



- 1. Transferring the data from TS I/F to Cell Processor.
- 2. Processing the data with XDR.
- 3. Recording the data on HDD.
- 4. Reading the data on HDD.
- 5. Processing the data with XDR.
- 6. Transferring the data from XDR to DDR2, Audio I/F.
- 7. Transferring the data fromDDR2 to Video out I/F.

**Digital Tuner** 



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# **Key Architecture (1/2)**

### Internal Bus Architecture

- > Quality of Service (QoS)
  - -Bandwidth allocation by bus arbitration
    - mechanism.(with priority in every cycle.⇒TDM .)

#### Hierarchical Architecture

-Dividing the bus according to the required features.

**Real time bus and Best effort.** 

### DDR2 memory interface

- Dedicated DMA controller
  For streaming data
  - -For streaming data.

# **Key Architecture (2/2)**

#### Other Features

Virtual Channel Mechanism

To avoid blocking for data flow.



Multiple thread mechanism
Multi/Single threads are alter

Multi/Single threads are alternative.

- Pipelined data processing
- Data ordering mechanism

## **FlexIO controller**



# **Dedicated DMA controller**

#### < For DDR2 memory >



# Requirement vs. Bandwidth < MBUS, SBUS, HBUS >



The each maximum bus bandwidth(2.66GByte/s) is sufficient for the every required module bandwidth.

# **Bandwidth Allocation Results**



# The bandwidth allocation mechanism can satisfy the BUS requirement from each module/bus bridge.



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# **Chip Photo**



- Process
  - 90nm CMOS Process
  - 7 Layer Cu
- Frequency -333MHz
- Package PBGA[FC],1385pin,
  - 40mm<sup>□</sup>,1mm pitch
- Chip Size
  - 12.71mm x 12.71mm
- - Core: 1.2V
  - I/O: Multiple voltages for various peripherals



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# Conclusion

- Super Companion Chip for "Cell" processor system has been successfully developed.
- Both rich audio visual features supporting HD and PC I/O features are integrated on the chip.
- Simultaneous 48 MPEG-2 SD stream decoding has been demonstrated by utilizing SCC's high bandwidth bus with QoS capability.